

D2>

E2

⊕ 0.10 C A B

DETAIL A

42X L

42X b

е

BOTTOM VIEW

e/2

0.10 C A B

0.05 С NOTE 3

WQFN42 3.5x9, 0.5P

DATE 15 FEB 2010

NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.70	0.80	
A1	0.00	0.05	
А3	0.20 REF		
b	0.20	0.30	
D	3.50 BSC		
D2	1.95	2.15	
Е	9.00 BSC		
E2	7.45	7.65	
e	0.50 BSC		
K	0.20		
۲	0.30	0.50	
L1	0.00	0.15	

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

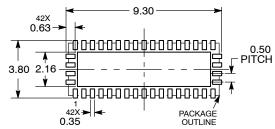
= Assembly Location WL = Wafer Lot

YY = Year WW = Work Week

= Pb-Free Package G

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

RECOMMENDED MOUNTING FOOTPRINT



DIMENSIONS: MILLIMETERS

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DESCRIPTION:	WQFN42 3.5X9, 0.5P		PAGE 1 OF 1

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